



S/N 09/893588

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant:	Takashi Kumamoto	Examiner:	Alonzo Chambliss
Serial No.:	09/893588	Group Art Unit:	2827
Filed:	June 29, 2001	Docket No:	884.A98US1
Title	MULTI-PURPOSE PLANARAZING/BACK-GRIND/PRE-UNDERFULL ARRANGEMENTS FOR BUMPED WAFERS AND DIE		
Assignee:	Intel Corporation	Customer No:	21186

PETITION FOR A TWO-MONTH EXTENSION OF TIME

MS RCE
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

In accordance with the provision of 37 CFR § 1.136(a), it is respectfully requested that a two-month extension of time be granted in which to respond to the Final Office Action mailed August 1, 2003, said period of response being extended from November 1, 2003 to January 1, 2004.

Please charge Deposit Account No. 19-0743 in the amount of \$420.00 to cover the required extension fee. Please charge any additional fees or credit overpayment to deposit Account No. 19-0743.

Respectfully Submitted

TAKASHI KUMAMOTO

By his Representatives,

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12/23/2003 HGBREM1 00000040 190743 09893588
02 FC:1252 420.00 DA

Date: Dec. 19, 2003 By: Ann M. McCrackin
Ann M. McCrackin
Reg. No: 42,858

CERTIFICATE UNDER 37 CFR § 1.8: The undersigned hereby certifies that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail, in an envelope addressed to: MS RCE, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on this 19 day of December, 2003

Name: KACIA LEE

Signature: Kacia Lee